

# **KEK Bouncer-type Modulator**

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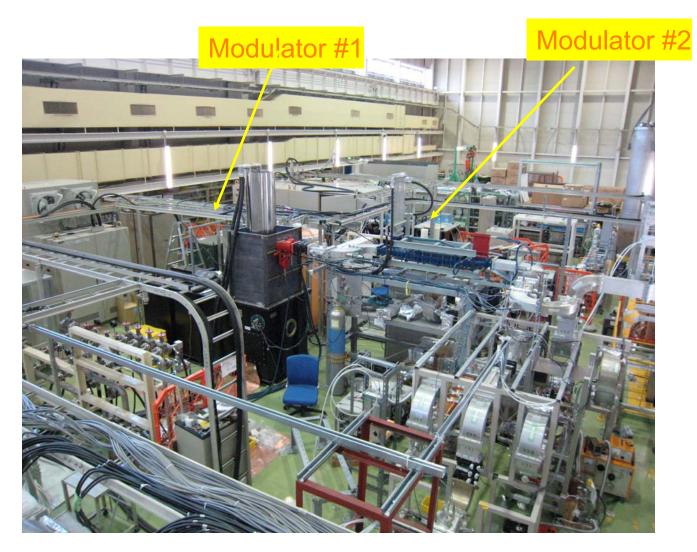
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   STF Modulator #1 for 5 MW Klystron
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### **Present Status on STF**

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STF Klystron gallery



## **5 MW Single-Beam Klystron**

**Specifications (TH2104)** 

- Operating Frequency
- RF Pulse Width
- Peak Output Power
- Beam Voltage
- Beam Current
- Micro-Perveance
- Repetition Rate
- Efficiency

1.3 GHz 1.5 ms 5 MW 124 kV 92 A 2.1 5 pps 46 %



TH2104A



## **10 MW Multi-Beam Klystron**

**Specifications (Toshiba E3736)** 

- Operating Frequency GHz
- RF Pulse Width
- Peak Output Power
- Number of Beams
- Beam Voltage
- Beam Current
- Micro-Perveance
- Repetition Rate
- Efficiency

1.3 1.5 ms 10 MW 6 120 kV 140 A 3.4 5 pps 60 %





## **STF Modulator #1**

•To rapidly start the project and reduce its cost, the first modulator was converted from a klystron modulator system obtained from the Power Reactor and Nuclear Fuel Corp (PNC).

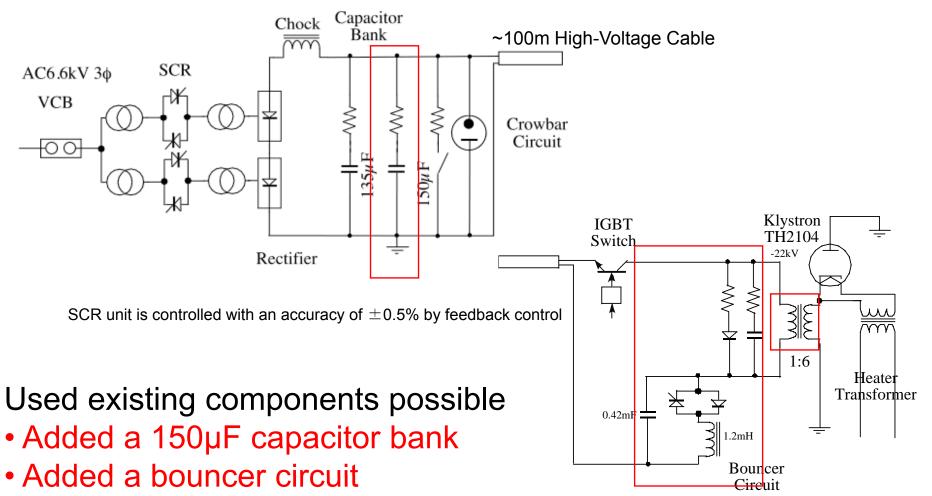
•The PNC modulator had been originally designed and built about 10 years ago for the positron factory project at PNC.

•It was first time that we built a bouncer-type modulator Design parameters of STF Modulator #1

Peak Output Power	12.0 MW	
Secondary Output Voltage	130	
kV		
<ul> <li>Secondary Output Current</li> </ul>	92 A	
<ul> <li>Pulse Flat-top width</li> </ul>	> 1.5 ms	
• Rise time(10-90%)	< 0.1 ms	
Flatness	<b>±0.5%</b>	
Repetition Rate	5 pps	
Pulse Transformer Ratio	1:6	



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• Exchanged a new 1:6 pulse transformer





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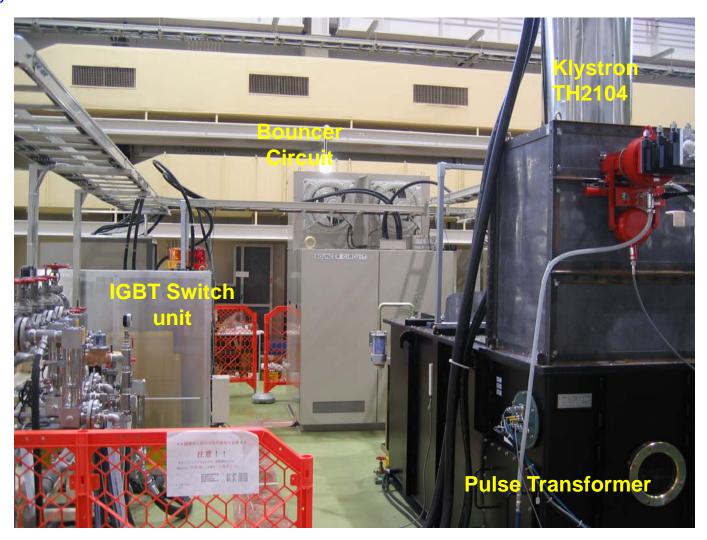


### DC Power Supply(Tent House)



## **STF Modulator#1**

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### **Klystron Gallery**



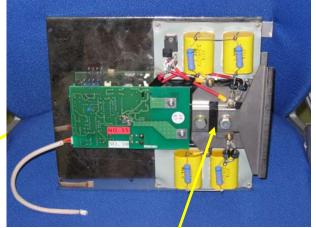
## **IGBT Switch**

#### **36 IGBT plug-in boards in series**



#### Switch assembly

Trigger: Optical fiber cable



#### IGBT Driver Board



IGBT Mitsubishi CM600H-24H Rated Voltage : 1200V Rated Current : 600A

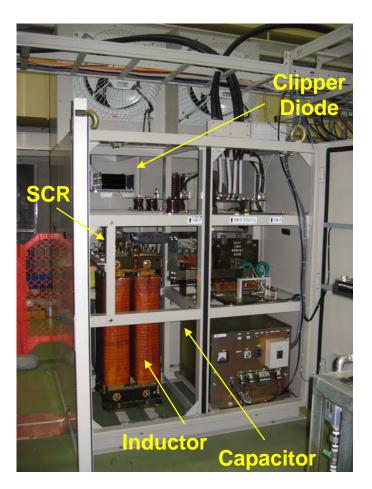


## **Bouncer Circuit for STF Modulator #1**

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**Bouncer unit** 



#### **Inside of Bouncer Circuit**



## **Pulse Transformer for STF Modulator #1**

#### Specification of Pulse Transformer

- Primary voltage
   21.7 kV
- Primary current 552 A
- Primary impedance 36.8Ω
- Secondary voltage 130 kV
- Secondary current
   92 kV
- Secondary impedance 1413 Ω
- Flat-top pulse width 1.5 ms
- Rise-time(10-90%) 40µs
- Pulse droop < 3%
- Step-up ratio 1:6

#### **Features**

- Core comprises 39 subcores.
- Reuse 25 subcores that were used in the JHF to reduce its cost.
- Core material is 0.22mm thick silicon steal ribbon.
- DC bias
- Auto winding-type
- Size of the tank
- 2.9 m(W) x 1.2 m(D) x 1.3 m(H)
- Total weight weight including the oil 9.1 tons (core 4.4 tons)
- Heater transformer is isolation transformer-type.



## Pulse Transformer for STF Modulator #1

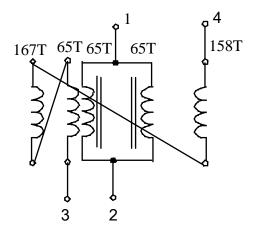
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#### **Design parameters**

(in the secondary side)

- Primary inductance : 60 H
- Leakage inductance : 20 mH
- Distributed capacitance : 570 pf



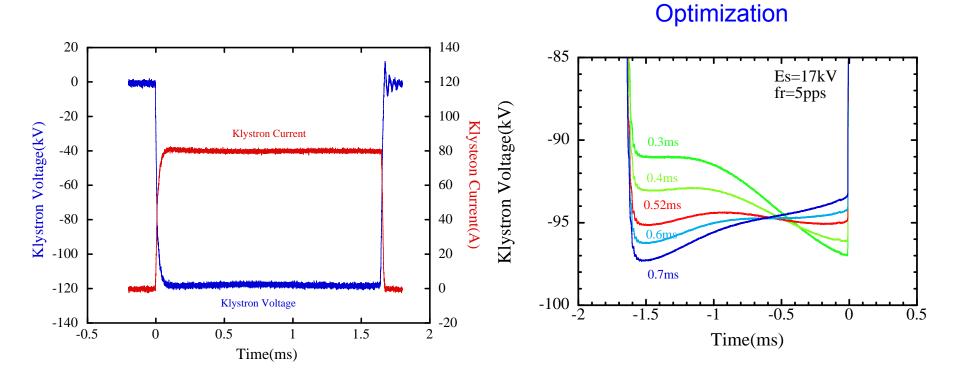
Schematic winding diagram

Core-and coil assembly



## **Klystron voltage and current waveforms**

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Es=21.5kV, Pw=1.7ms, fr=5pps Peak voltage=120 kV, Peak current = 81A Rise-time(10-90%)=33µs Output rf power=3.9 MW

Es=17kV, Pw=1.7ms, fr=5pps Flatness=0.8%(p-p)

**Bouncer Timing** 

Klystronl voltage is limited at 21.5 kV because each device voltage becomes 950V due to circuit inductance.



## **STF Modulator#2**

- New modulator capable of driving a 10 MW MBK klystron
- Based on TESLA/FNAL design.
- More compact and highly reliable modulator design
- Test operation has been finished.

#### **Features :**

(1) Pulse Transformer

- Use a 1:15 step-up ratio to realize a more compact switch, which can be used in higher rated voltage and current devices such as IEGT(Injection Enhanced Gate Transistor) in the future
- (2) DC Power Supply

Use four 50 kW switching power supply in parallel

(3) Capacitor Bank

Use high energy density SH(Self-Healing)type capacitors

#### (4) Main Switch

Use a highly reliable conventional IGBT device, which is the same as the device used in STF modulator #1

(5) No crowbar

Eliminate a crowbar circuit by reinforcing the IGBT switch protection

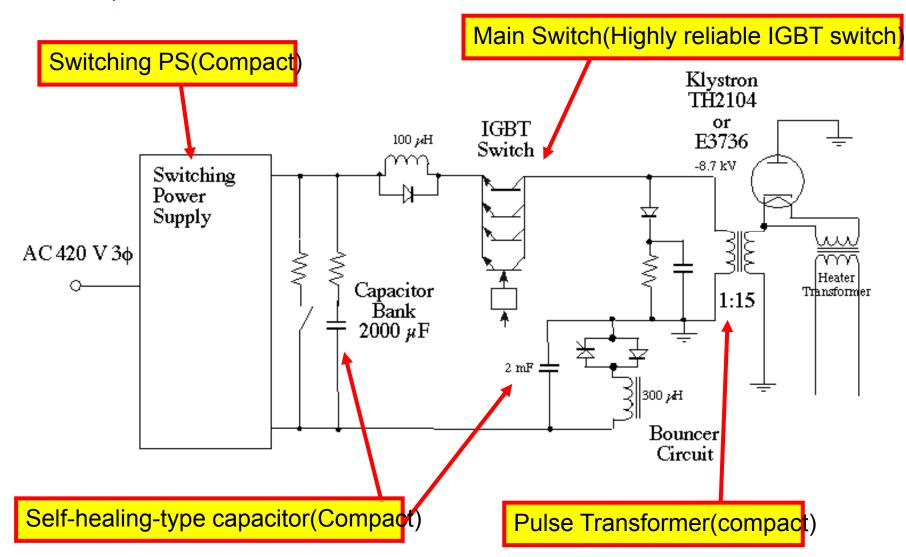


Peak Output Power	16.8(12.0) MW
Secondary Output Voltage	120(130) kV
Secondary Output Current	140(92) A
Pulse width	1.7 ms
Flat-top width	> 1.5 ms
Rise time(10-90%)	< 0.1ms
Flatness	± <b>0.5%</b>
Repetition Rate	5 pps
Pulse Transformer Ratio	1:15
Capacitor Bank	2000 µF<20%droop>
LC Bouncer	
Inductance	2.0 mH
Capacitance	0.3 mF
Main Switch	
Voltage	8.8(9.5) kV
Current	2100(1380) A

()=5MW Single Klystron

## Schematic Circuit Diagram of STF Modulator #2

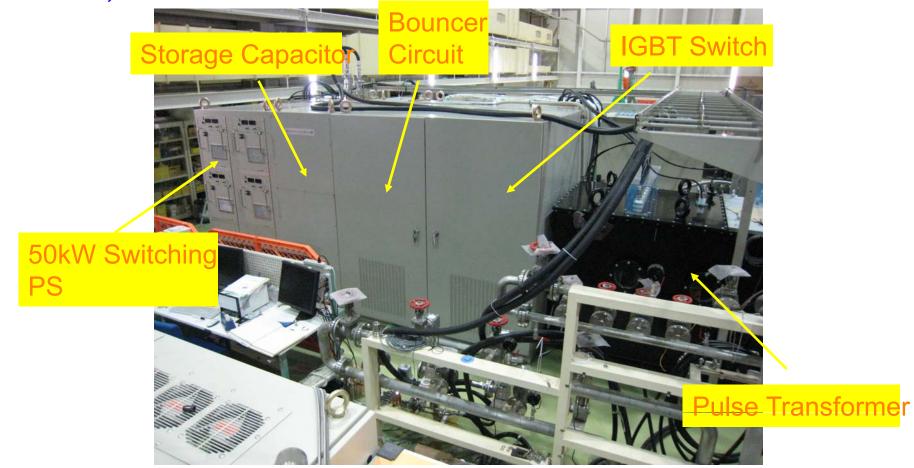
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## **Overview of STF Modulator #2**

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The size of the main cabinet is 4.2m wide x 2.2m deep x 2.2m high



## **DC Power Supply**

**Specifications** 

- 4 switching power supplies operation in parallel
- Input voltage: 420 V, 3 phase, AC
- Output voltage : 10 kV
- Charging rate : 200 kJ/s
- Switching frequency: 20 kHz
- Repetition rate : 5 Hz
- Voltage regulation : < 1% at 5 Hz
- Cooling : Water cooling



Four 50 kW switching power supplies



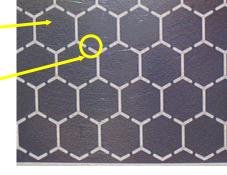
## **Capacitor Bank**

#### Features:

- 4 SH capacitors in parallel
- Capacitance: 500 µF
- Rated voltage: 11 kV DC
- Metallized PP films
- Form a small segmented metallization pattern to prevent a catastrophic failure that may arise from an internal high energy discharge.
- Design dielectric strength : 300V/µm
- Design Lifetime : 100,000 hours at 5 pps
- Size : 68 cm W x 25 cm D x 68 cm H
- Energy density : 270 kJ/m<sup>3</sup>
- Developed by Nichicon Co.



Metallization Fuse part



**Capacitor structure** 

#### Before breakdown

After breakdown

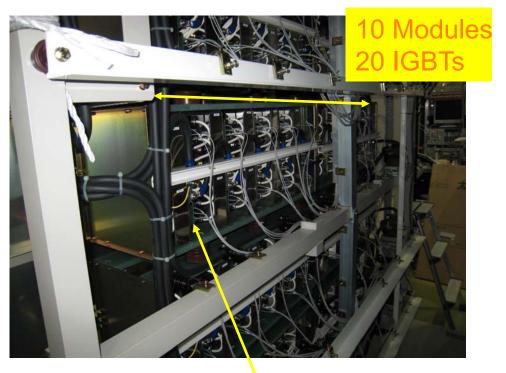


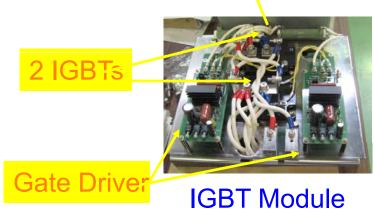
## **Main Switch**

- Device : Mitsubishi IGBT
  - CM600H-24H 1200V, 600A
- Structure : 20 series and 4 parallels
- Gate signal : optical fibre cable
- dc power for the gate drive circuit is fed through the main line.

• To detect the short-circuiting of the device, each device voltage is measured; a device is decided to have shorted if its voltage is less than 50 V when the switch turns off, the device is decided to be short. In such situation, the switch is rapidly stopped to protect it.

• Has fast over-current protections for each IGBT module, the primary and secondary of the pulse transformer.

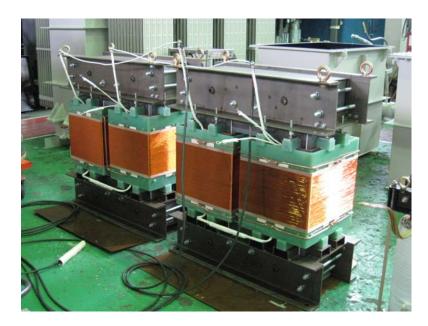






## Pulse Transformer for STF Modulator #2

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Core-and coil assembly

#### Features;

- Optimized for a rise-time of  $\sim 100 \ \mu s$ Leakage inductance ~ 39 mH
- Divided into two transformers One for full withstanding voltage The other for half withstanding voltage
- Laminated core
- Material is 0.3 mm thick silicon steal ribbon
- DC bias
- Iso winding
- Heater transformer is isolation transformer-

## type Size of the tank

• 2.2m W x 1.1m D x 1.4m H

## Design parameter (in the secondary Total weight : 8.3 t

- Primary inductance : 92 H
- Leakage inductance : 36 mH
- Distributed capacitance : 844 pF

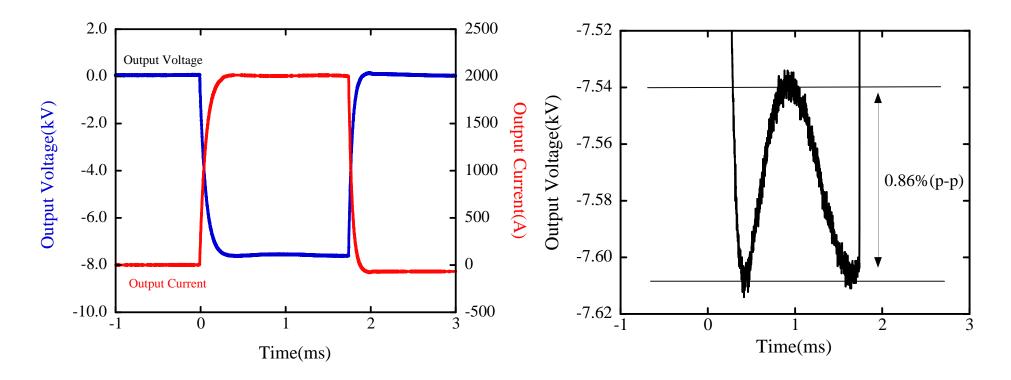
• Two pulse transformer : 2.3 t

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x2
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- Tank : 1.5 t
- Oil : 2.2 t



# Dummy load : 3.8 $\Omega$ + 200 $\mu H$ Reactor in the primary side

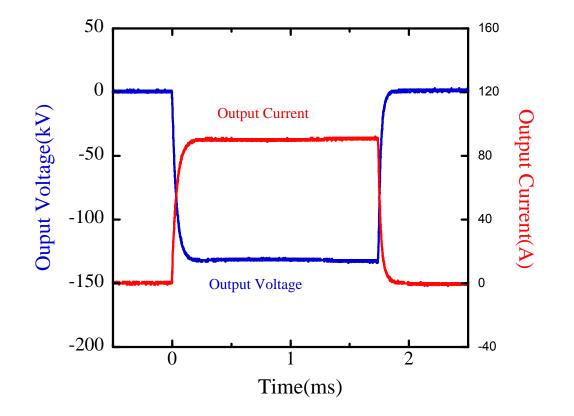


Es=9.1 kV, Pw=1.75 ms, fr=5 pps Peak pulse voltage = -7.57 kV, Peak pulse current = 2009 A

## Output Voltage and Current Waveforms

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Dummy load : 1400  $\Omega$  resistor in the secondary side of the pulse transformer



Es=10 kV, Pw=1.75 ms, dc bias=5 A, Bouncer trigger timing= 0.4 ms Peak pulse voltage = 133 kV, Peak pulse current = 90 A, Rise-time(10-90%)= ~130 µs

# Compact IEGT Switch Development

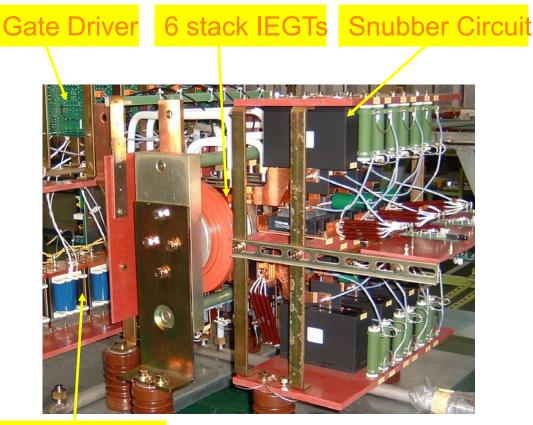
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## 9kV, 2100 A, 1.7 ms, 5Hz

Main Switch for modulator #2

Comparison of IEGT and IGCT

Device	IEGT	IGCT
	ST2100GXH24A	5SHY35L4511
	(toshiba)	(ABB)
Voltage	4.5kV	4.5kV
Turn-Off	5500A	3800A
Current		
RMS	2100A	2200A
Current		
di⁄dt	5000A ⁄ μ s	1000A ⁄ μ s
Outline	$\phi~125 { m mm}$ post	$\phi$ 85mm post
	26.5mm t	26.5mm t
Gate	Voltage Drive	Current Drive
	20W Power	100W Power



Transformer for gate driver PS

#### **IEGT Switch Assembly**

Trigger: Optical fiber cable Size : 900 mm W x 920 mm D x 685 mm H

<u>IEGT</u> (Injection Enhanced Gate

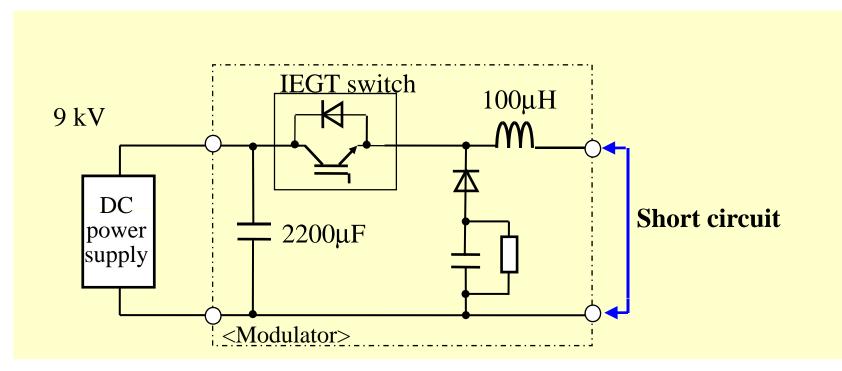
<u>Transistor</u>)

Cooperation with TMEIC(Toshiba-Mitsubishi Electric Industrial Systems Corporation)



## **IEGT Tern-off Test**

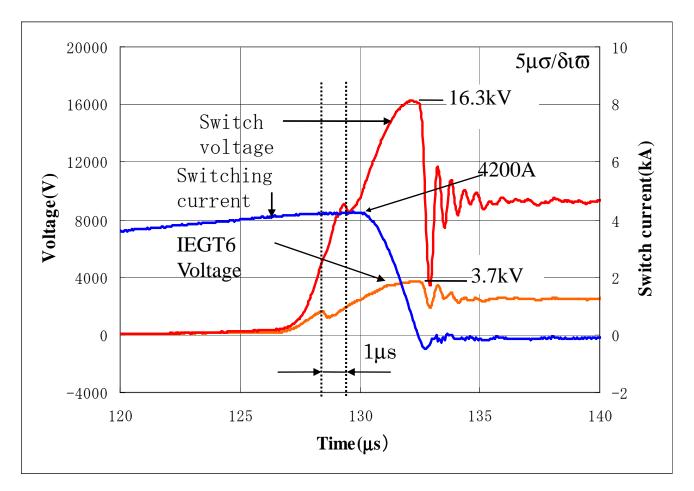
In case of the short-circuiting in the primary side of the pulse transformer



This test is very hard condition for the switch.



## **IEGT Turn-off Test Result**



The data show the switch was able to turn off at 9 kV, 4200A and the transient voltage of the switch was 16.3 kV(< 27 kV). Over-current detection level : 2520A



## Summary

•It was the first time that KEK built a bouncer type modulator. Two bouncer-type modulators for STF have been built at KEK.

•The first modulator has converted from an old klystron modulator system to start up the project quickly. Pulses with a peak voltage of 120 kV, a peak of current of 81A, a width of 1.7 ms, a rise time of  $33\mu$ s(10-90%), a flat-top width of 1.5 ms within 0.8%(peak to peak) were successfully generated at 5 pps and the output rf power then reached 3.9 MW. This modulator is used for a high power test of the coupler for the cavity.

• The second modulator capable of driving a 10 MW klystron is now complete and will be used for high power test of a 5 MW klystron.

• High-power test of IEGT switch has been performed in cooperation with TMIC and the results show very good performance